



**America Semiconductor**

**Silicon Fast Recovery Diode**

**FR16B05 thru  
FR16JR05**

**$V_{RRM} = 100\text{ V} - 1000\text{ V}$**

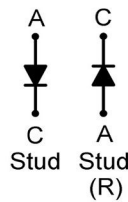
**$I_F = 16\text{ A}$**

**Features**

- High Surge Capability
- Types up to 1000 V  $V_{RRM}$

**Note:**

1. Standard polarity: Stud is cathode.
2. Reverse polarity (R): Stud is anode.
3. Stud is base.



**DO-4 Package**



**Maximum ratings, at  $T_j = 25\text{ °C}$ , unless otherwise specified ("R" devices have leads reversed)**

Parameter	Symbol	Conditions	FR16B(R)05	FR16D(R)05	FR16G(R)05	FR16J(R)05	Unit
Repetitive peak reverse voltage	$V_{RRM}$		100	200	400	600	V
RMS reverse voltage	$V_{RMS}$		70	140	280	420	V
DC blocking voltage	$V_{DC}$		100	200	400	600	V
Continuous forward current	$I_F$	$T_C \leq 100\text{ °C}$	16	16	16	16	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25\text{ °C}$ , $t_p = 8.3\text{ ms}$	225	225	225	225	A
Operating temperature	$T_j$		-65 to 150	-65 to 150	-65 to 150	-65 to 150	°C
Storage temperature	$T_{stg}$		-65 to 175	-65 to 175	-65 to 175	-65 to 175	°C

**Electrical characteristics, at  $T_j = 25\text{ °C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	FR16B(R)05	FR16D(R)05	FR16G(R)05	FR16J(R)05	Unit
Diode forward voltage	$V_F$	$I_F = 16\text{ A}$ , $T_j = 25\text{ °C}$	1.4	1.4	1.4	1.4	V
Reverse current	$I_R$	$V_R = 100\text{ V}$ , $T_j = 25\text{ °C}$	25	25	25	25	$\mu\text{A}$
		$V_R = 100\text{ V}$ , $T_j = 150\text{ °C}$	6	6	6	6	mA
<b>Recovery Time</b>							
Maximum reverse recovery time	$T_{RR}$	$I_F = 0.5\text{ A}$ , $I_R = 1.0\text{ A}$ , $I_{RR} = 0.25\text{ A}$	500	500	500	500	nS
<b>Thermal characteristics</b>							
Thermal resistance, junction - case	$R_{thJC}$		1.5	1.5	1.5	1.5	°C/W





Figure .1-Typical Forward Characteristics

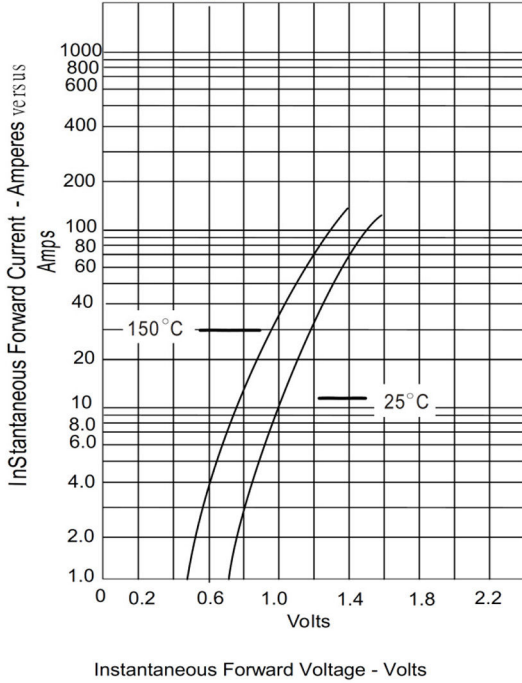


Figure .2- Forward Derating Curve

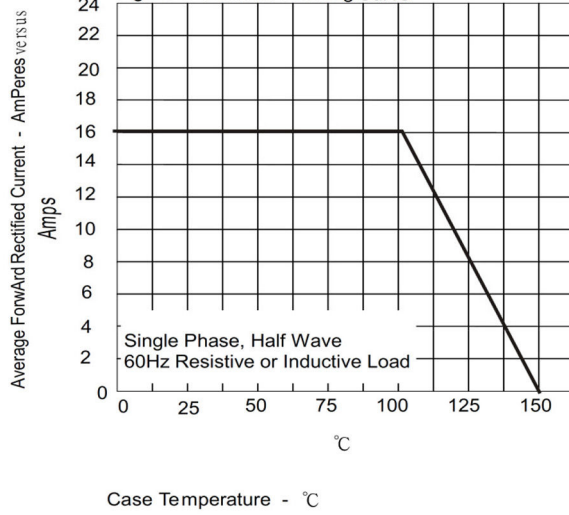


Figure .4-Typical Reverse Characteristics

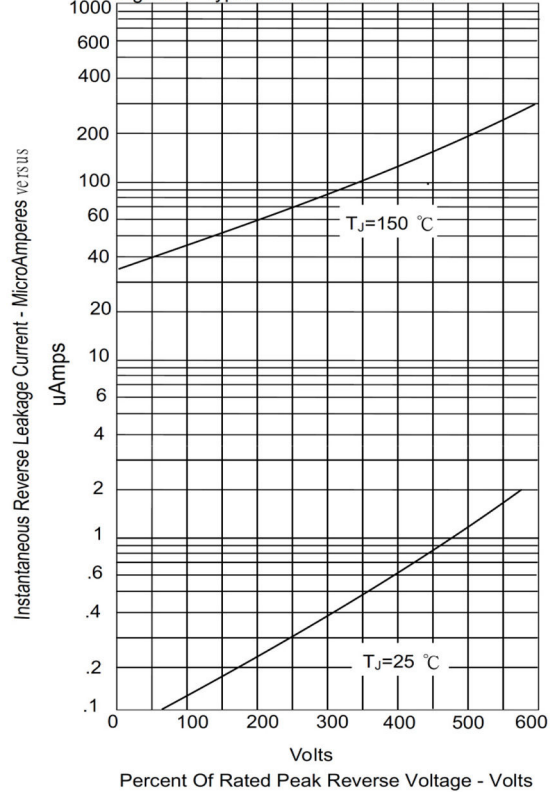


Figure .3- Peak Forward Surge Current

